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ARTICLE TYPE

Self-heated silicon nanowire array: selective surface modification with catalytic nanoparticles by nanoscale Joule heating and its gas sensing applications

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We demonstrated novel methods for selective surface modification of silicon nanowire (SiNW) devices with catalytic metal nanoparticles by nanoscale Joule heating and local chemical reaction. The Joule heating of a SiNW generated a localized heat along the SiNW and produced endothermic reactions such as hydrothermal synthesis of nanoparticles or thermal decomposition of polymer thin film. In the first method, palladium (Pd) nanoparticles could be selectively synthesized and directly coated on a SiNW by the reduction of Pd precursor via Joule heating of the SiNW. In the second method, a sequential process composed of thermal decomposition of polymer, evaporation of Pd thin film, and lift-off process was utilized. The selective decoration of Pd nanoparticles on SiNW was successfully accomplished by using both methods. Finally, we demonstrated the applications of SiNWs decorated with Pd nanoparticles as hydrogen detectors. We also investigated the effect of self-heating of SiNW sensor to its sensing performance.

Introduction

Among various nanomaterials, silicon nanowires (SiNWs) are one of the good candidates for industrial applications due to the well-established silicon-based nanoelectronics technology. Moreover, the electrical properties of SiNWs can be easily controlled and the surface can be simply modified with chemical treatment. Therefore, there have been many researches about SiNWs for sensor applications in the last decade¹⁻⁸. The applications range from the detection of chemical species including pH^{1,2} and gases³ to the detection of biological species such as DNA⁴, proteins⁵, cancer⁶, and viruses⁷. Due to the high surface-to-volume ratio, the SiNW-based sensors have shown the detection limit down to a single-molecule level⁷.

Since a pristine SiNW does not possess significant selectivity to most chemical or biological species, surface modification steps are essential for the selective detection. The surface modification methods can be classified into two categories: global surface modification such as self-assembled-monolayer (SAM) coating⁹ and local surface modification such as dip-pen lithography¹⁰, AFM surface modification¹¹, electrostatic force lithography¹² and micro contact printing^{13,14}. Although global surface modification method provides high throughput surface modification, local modification technique is required as the size of sensors is scaled down and the sensors are highly integrated into a small chip. Especially, sensor devices for multiplexed detection require local surface modification of integrated nanowire array with heterogeneous functional groups. However, the low throughput issue in local surface modification methods has not yet been

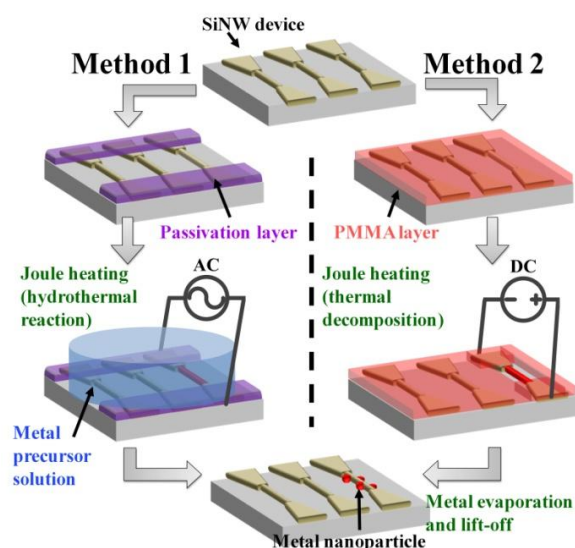
resolved.

In this paper, we introduce new methods for the selective surface modification of SiNWs based on nanoscale localized Joule heating. We have previously studied the nanoscale heating effects of silicon and metal nanowires and their applications as the nanoscale heaters^{15,16}. Our approach in this work is to utilize these nanoscale heating phenomena for the selective surface reactions (ex. thermal decomposition of polymer thin film or hydrothermal synthesis of metal nanoparticles) and surface modification on the SiNWs. These proposed methods provide high-throughput surface modification since self-aligned modification of SiNWs is enabled and no additional alignment process is required.

Scheme 1 depicts the schematic of these methods. In method 1, SiNW is Joule-heated by applying a voltage in a metal precursor solution and metal nanoparticles are directly synthesized and coated on the surface of SiNW. In method 2, polymer (eg. PMMA) thin film coated on the SiNW is thermally decomposed by Joule heating of SiNW. Then, evaporation of metal thin film and lift-off process are used for the selective decoration of metal nanoparticles on the SiNW.

Experimental Procedure

SiNW devices were fabricated by conventional top-down technology such as electron beam lithography (EBL) and reactive ion etching (RIE). A silicon on insulator (SOI) wafer was used as the starting substrate. The wafer had a top silicon (Si) layer with a thickness of 100 nm and a 400 nm thick buried oxide (SiO₂) layer underneath the top Si layer. By thermal oxidation and time-



Scheme 1 Schematic description of surface modification by self-heating of nanowire: In method 1, nanoparticles were formed by hydrothermal reaction via Joule heating of the SiNW. In method 2, metal thin film was locally deposited on a SiNW through PMMA decomposition, metal evaporation and lift-off.

controlled wet etching of the oxide layer, the top Si layer was thinned down to 50 nm and covered with a 10 nm thick SiO₂ layer. Then, the SOI wafer was doped with boron ions (doping concentration: $7 \times 10^{17} \text{ cm}^{-3}$) by ion implantation process and a subsequent rapid thermal annealing process at 1000 °C for 10 seconds. SiNWs were patterned by RIE process using a Cr layer as an etch mask which had been defined by the EBL and lift-off processes. Polymethyl methacrylate (PMMA) was used as the e-beam resist and polymethylglutarimide (PMGI, MicroChem's PMGI SF2) was used as a lift-off layer. Both PMGI and PMMA films were deposited on the SOI wafer by spin coating. Scanning electron microscope (SEM, JEOL JSM-6510) based EBL system equipped with NPGS (Nabity System, Inc) unit defined the geometry of nanowires 100 nm wide and 3 μm long with an acceleration voltage of 30 kV and a dose of 320 μCcm⁻². The patterned film was developed by 3:1 (v/v) mixed solution of IPA (isopropyl alcohol) and MIBK (methyl isobutyl ketone) for 80 seconds and transferred into IPA for 60 seconds for further developing. Dipping the samples into 60 % AZ300MIF diluted by DI water 90 seconds resulted in the undercut etching of PMGI film for better lift-off. To remove the residual PMMA resist, oxygen plasma process was conducted. Then, a 20 nm thick Cr layer was deposited on the nano-patterned sample by e-beam evaporation. To perform metal lift-off process, PMMA and PMGI layers were cleaned by PMGI remover (PG remover, MicroChem) at 100 °C for a few minutes and by subsequent ultrasonication for a few seconds. SiNWs were patterned by etching a 10 nm SiO₂ layer and a 50 nm Si layer using RIE process (SF₆ gas) with nano-patterned Cr layer as an etch mask. Then, Cr layer was removed and the top SiO₂ protection layer was etched. Micro contact electrodes were defined by aligned UV photolithography and lift-off of 150 nm thick Al layer. Thermal annealing process was performed at 400 °C in a forming gas (mixture of 10 % H₂ and 90 % N₂).

The first method (Method 1 in Scheme 1) for selective surface modification of SiNW is the hydrothermal reaction of metal

precursor by nanoscale Joule heating of SiNW and is explained in the following: First, the electrodes are passivated by aligned photolithographic patterning of photoresist and its thermal cross-linking in order to prevent unnecessary electrochemical reaction between the micro contact electrodes and the precursor solution. In specific, 2 μm thick photoresist (AZ NLOF 2035, MicroChem) was deposited on a SiNW device by spin-coating at 5000 rpm and baking at 110 °C for 80 sec. The layer was patterned for opening of SiNW array by UV exposure and development of the resist. Additional baking of the passivation layer at 200 °C for 1 hour on a hot plate gave chemical resistivity due to thermal cross-linking of photoresist. Palladium (Pd) precursor solution was prepared by a mixture of 16 mL of 1 mM K₂PdCl₄ and 200 μL of 30 mM sodium citrate¹⁷. Aqueous sodium hydroxide solution was added to the Pd precursor solution to set pH=11. For further prevention of the electro-chemical reaction, alternative voltage with a sinusoidal wave form was applied on the SiNW by a function generator (33210A, Agilent) and an amplifier. The root mean square amplitude and frequency for the AC voltage were 18.8 V and 1 kHz, respectively.

Another method (Method 2 in Scheme 1) is based on the selective and localized thermal decomposition of PMMA by using Joule heating of the silicon nanowire, metal layer deposition, and lift-off process. A 40 nm thick PMMA (950 PMMA C, MicroChem) layer was deposited on a SiNW device by spin-coating at 5000 rpm and baking at 180 °C for 15 min. For the Joule heating of SiNW and thermal decomposition of PMMA, a DC potential of 60 V was applied across the nanowire for several minutes. Nanoparticles were decorated on the SiNW by depositing a very thin metal film (<2 nm) using an electron-beam evaporator and removing the PMMA layer through dipping in acetone with ultrasonication. The structure of the SiNW decorated by metal nanoparticles was characterized by field-emission scanning electron microscopy (FE-SEM, Sirion). The morphology of decomposed PMMA was measured by using an atomic force microscopy (AFM, Park system XE-100).

The SiNWs decorated with Pd nanoparticles by using two methods were used as hydrogen (H₂) sensors. The SiNWs were exposed to 0.5 % H₂ gas made by mixture of synthetic air (20% O₂ and 80% N₂) and 1% H₂ gas (1 % of H₂ and 99 % of N₂). Air and H₂ gas were flowing at the same time with flow rate of 300 sccm each. The resistance of the Pd decorated SiNW was measured at a room temperature condition. To observe the H₂ sensing characteristics of the Pd decorated SiNW, constant DC voltage of 0.5 V was applied across the nanowire and the current was measured by a source meter (Keithley 2400 SourceMeter) controlled by computer based program (LabView, National Instrument) while the nanowire was exposed to the H₂ gas and air.

Results and Discussion

The Joule heating of SiNW was calculated by a numerical simulation (COMSOL Multiphysics). A SiNW with a length of 3 μm, width of 100 nm, and thickness of 50 nm was located on a Si substrate (thickness of 200 μm, area of 40 μm x 40 μm) with a top silicon dioxide (SiO₂) layer (thickness of 400 nm, area of 40 μm x 40 μm) (Fig. S1). The temperatures at the top plane of the environment and the bottom plane of the substrate were fixed at

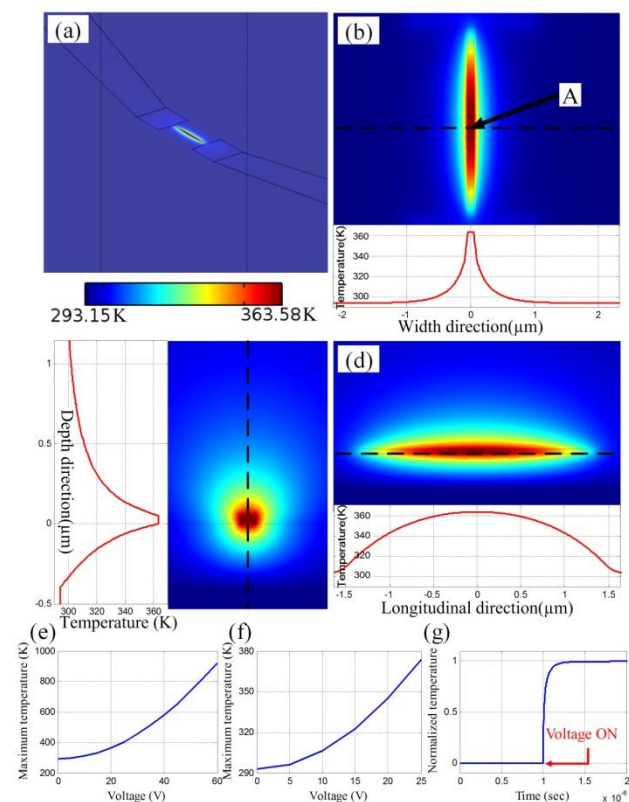


Fig. 1 Steady-state and transient temperature analysis of SiNW during Joule heating by numerical simulation: (a) three dimensional temperature distribution near Joule-heated SiNW, (b) two and one dimensional temperature profiles in x-y plane on the surface of silicon oxide, (c) two and one dimensional temperature profiles in x-z plane along the center of nanowire, (d) two and one dimensional temperature profiles in y-z plane along center of nanowire, (e-f) temperature at point A versus applied DC voltage in (e) air environment and (f) water environment, and (g) step response of the temperature at point A to a constant DC voltage.

room temperature (293.15 K) and the boundary condition for the side walls of the environment was set to be a thermal insulation because the region and power of the Joule heating of SiNW are very small. The electrical conductivity of Si doped by boron at a concentration of $7 \times 10^{17} \text{ cm}^{-3}$ was 1429 S/m at room temperature and the temperature dependence of the electrical conductivity was modeled as below:

$$\sigma = \sigma_0 \frac{1}{(1 + \alpha(T - T_0))}$$

where σ_0 is the electrical conductivity at room temperature, α is the temperature coefficient of resistance, T is the temperature, and T_0 is the room temperature (293.2K). Here, α was set as 0.0002 K^{-1} for the given doping level¹⁸. Other material properties were employed from the database of the simulation software. An electrical bias was applied across the circuit and heat was generated by Joule heating of SiNW. The heat was mainly dissipated by conductive heat transfer to the substrate and convective heat transfer to the air or water environment above the nanowire device.

Fig. 1 (a-d) show the simulation result of SiNW's Joule heating by the numerical simulation. A maximum temperature of 363K was observed at the center of SiNW when an electrical bias of 20 V was applied. The cross-sectional temperature profile of

the simulation result shows that the Joule heating of SiNW generates a highly localized heating in the nanoscale space. The maximum temperature gradient was 0.765 K/nm ($= 765 \text{ K}/\mu\text{m}$) at the edge of SiNW and the temperature at a distance of $1 \mu\text{m}$ from the center of SiNW was 296.4 K which is similar to the room temperature (293.2 K). The temperature of SiNW was controlled by adjusting the applied voltage and affected by the surrounding media. Fig. 1 (e-f) depict the maximum temperature of SiNW versus the applied electrical bias in air and water environments. The temperature of SiNW reached $100 \text{ }^\circ\text{C}$ in water environment and $132 \text{ }^\circ\text{C}$ in air environment when 25 V was applied on SiNW. This difference is due to higher heat transfer coefficient and thermal capacity of water than those of air. The transient analysis shows that temperature is saturated within hundreds of nanoseconds (Fig. 1 (g)). The rise time (τ_r) required to reach from 10 % to 90 % of the steady-state temperature is 81.2 ns. This ultrafast thermal response originates from small thermal capacity of the SiNW heater. The temperature of SiNW can be manipulated within a few hundreds of nano-seconds by applying electrical bias and is high enough to produce endothermic chemical reactions such as thermal reduction of metal precursor and thermal decomposition of polymer thin film.

SiNWs can be heated not only by applying a DC potential but also by applying an AC potential. In fact, AC potential is sometimes beneficial to reduce unwanted electrochemical reactions in a liquid environment. We calculated temporal temperature change at the center of SiNW under AC potential with various frequencies by numerical simulation (Fig. S2). When the AC frequency is low, the time for heating and cooling is long enough to generate a sinusoidal temperature change of the nanowire. We can observe that the frequency of temperature change is twice of the AC potential's frequency because both positive and negative potentials generate the Joule heating of the

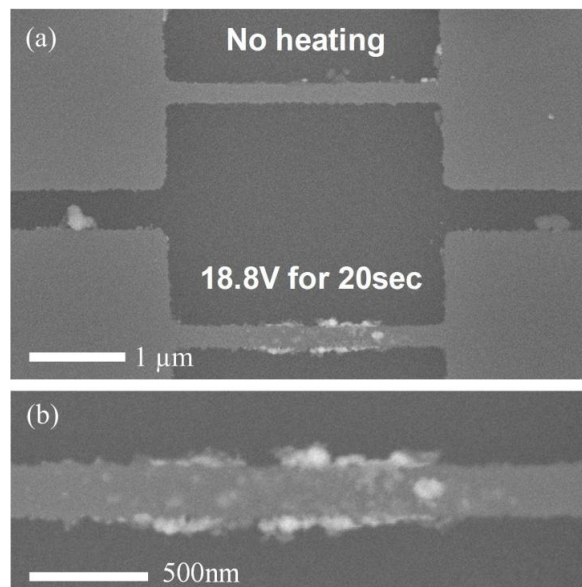


Fig. 2 SEM images of particle decorated SiNW via Joule heating in liquid metal precursor environment: (a) Pd nanoparticles selectively coated on the heated SiNW and (b) high magnification SEM image of Pd nanoparticles on the heated SiNW.

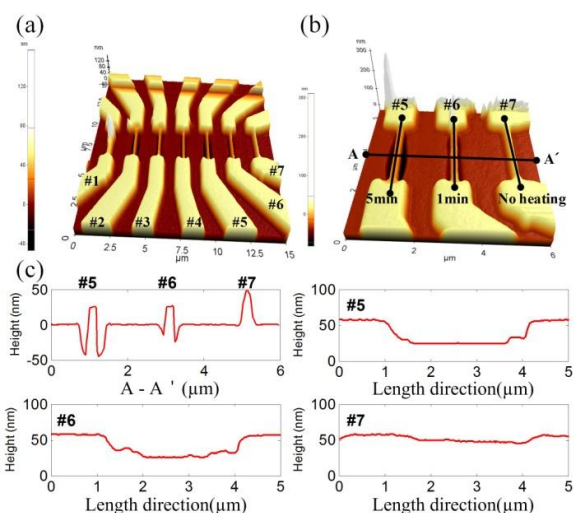


Fig. 3 Thermal decomposition of polymer by Joule heating of SiNW: (a) AFM image of PMMA thermal decomposition by DC voltage of 60 V across 3 μm long SiNW for different time period, (b) high resolution AFM image of PMMA decomposition, and (c) line profile in A-A' direction and length direction of nanowires #5, #6, and #7.

nanowire. Also, the maximum temperature achieved by an AC potential is identical to the temperature under the DC potential with the same amplitude of the AC potential. However, as the frequency of the AC potential is increased, heating and cooling of the nanowire cannot follow the fluctuation of the AC potential and therefore the maximum temperature of the nanowire is decreased. As shown in Fig. S2, the cutoff frequency (f_c) for the AC heating is between 1 MHz and 10 MHz. Below this frequency, the maximum temperature by the AC potential is larger than -3 dB of the maximum value by the DC potential. This frequency range is consistent with the cutoff frequency ($f_c=4.31$ MHz) calculated by the formula of $f_c \sim 0.35/\tau_r$ ¹⁹ where τ_r is the rise time (81.2 ns) in the step response.

Fig. 2 shows the result of selective synthesis and decoration of Pd nanoparticles by hydrothermal reaction through Joule heating of SiNW under an AC voltage with amplitude of 18.8 V and frequency of 1 kHz. Pd nanoparticles with an average diameter of 42 nm and standard deviation of 27 nm were grown on the Joule heated SiNW whereas they were not synthesized on the non-heated SiNW. Pd nanoparticles were synthesized near the center of Joule heated SiNW, which is the hottest area as calculated by the numerical simulation shown in Fig. 1 (b). During this experiment, the electrochemical reaction on the metal electrodes was eliminated by passivation layer, but electrochemical reaction on SiNW and Si electrodes could not be avoided since they were directly exposed to the reaction chemical. In order to prevent the electrochemical reaction, AC voltage was applied instead of DC voltage for Joule heating of SiNW. As mentioned above, the maximum temperature of the nanowire decreases with increasing AC frequency. Therefore, we used AC Joule heating with reasonable frequency (1 kHz) for heating the precursor solution to appropriate temperature as well as for reducing the electrochemical reaction.

Localized thermal decomposition of polymer also enabled selective surface modification of SiNWs. As the electrical bias was applied on a SiNW, nanoscale Joule heating along the SiNW was generated and the polymer was locally decomposed. As a

result, the surface of heated SiNW was opened for surface modification. For the localized thermal decomposition of polymer, a DC bias of 60 V was applied across a SiNW for 1 minute (nanowire #6) and 5 minutes (nanowire #5) after the coating of PMMA layer on the device chip. Fig. 3 shows that the nanowire surface was opened by selective decomposition of PMMA. As shown in Fig. 3(c), the decomposed area was widened as the heating time was increased. This result was caused by the spreading of heat from the nanowire to surrounding, whose amount is determined by the applied voltage and time. As shown in the line profile along the longitudinal direction of the nanowire (Fig. 3(c)), most thermal decomposition of PMMA occurred near the center region of the nanowire whereas both ends of the nanowire were still covered with PMMA. This can be attributed to the high temperature at the center of nanowire and lower temperature near the edge of the nanowire by the heat dissipation to the electrodes, which was confirmed by the numerical simulation. This self-passivation of electrode region is one of the attractive merits of the localized thermal decomposition of polymer using the nanoscale Joule heating of SiNW.

As explained above, by the PMMA decomposition, evaporation of Pd thin film and lift-off, selective coating of SiNWs with Pd nanoparticles can be realized. Fig. 4 (a, b) are the SEM images of the selectively deposited Pd nanoparticles along the Joule-heated SiNW. Because of the surface tension between Pd and SiNW, Pd nanoparticles were formed rather than a continuous Pd film in case of very small deposition thickness²⁰. Multiplexed SiNW array decorated with different metals was fabricated by repeating abovementioned selective surface modification process (i.e. PMMA decomposition, metal

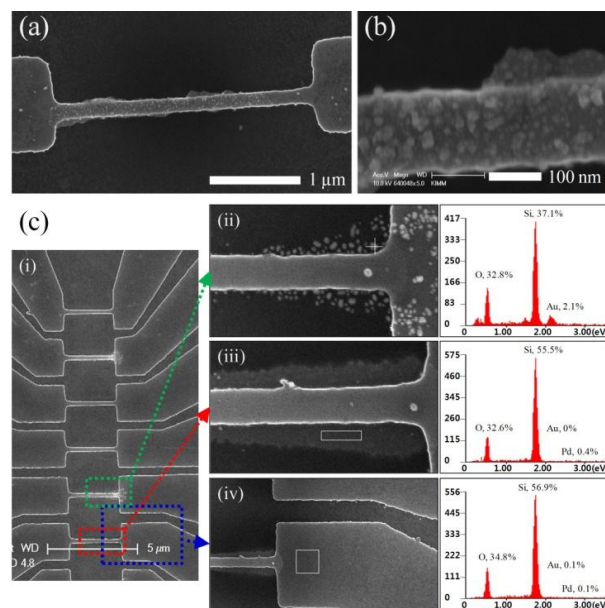


Fig. 4 Selective surface modification of SiNWs by PMMA decomposition and thermal evaporation: (a) SEM image of selective Pd decoration on a SiNW by method 2 (PMMA decomposed by applying a voltage of 60 V on the nanowire for 1 min), (b) high resolution image of (a), and (c) multiplexed SiNW array decorated with different metals (Au and Pd): (i) SEM image of SiNW array. SEM and EDS result of (ii) gold, (iii) palladium decorated SiNW and (iv) region without particle decoration.

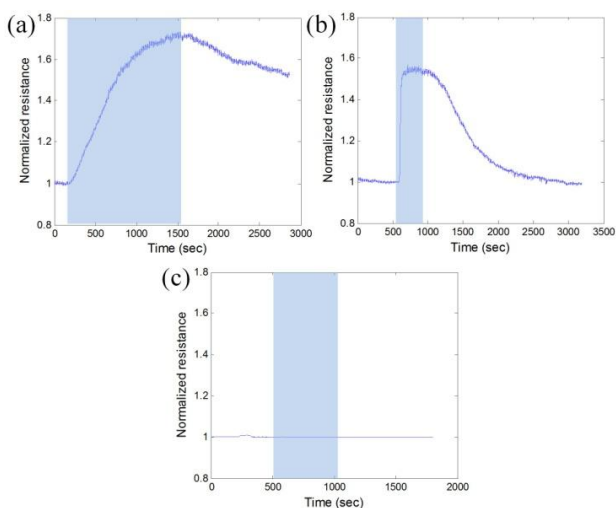


Fig. 5 Hydrogen sensing result of (a) the SiNW decorated with Pd nanoparticles by method 1, (b) the SiNW decorated with Pd nanoparticles by method 2, and (c) the bare SiNW. Blue area represents hydrogen exposure period and other areas represent the air exposure.

deposition and lift off) with different metals. In particular, we decorated nanowires with Au and Pd thin films. Fig. 4 (c) shows the SEM image of multiplexed SiNW array and the EDS results of metal decorated SiNWs. Au element is observed on nanowire #2 while negligible amount of Au is observed on nanowire #3 and elsewhere. Also, Pd element is observed on nanowire #3 while it can hardly be found on nanowire #2 and elsewhere. This result verifies that each nanowire can be selectively decorated with different metals by using the method we proposed above.

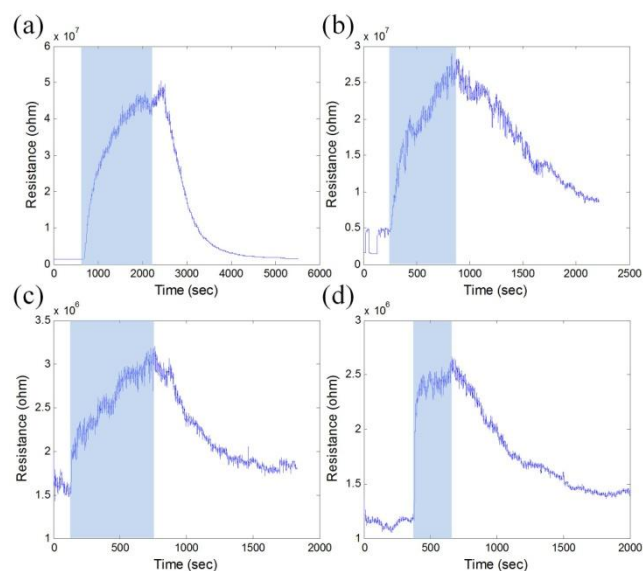
Fig. 5 (a) and (b) show the H₂ sensing results of SiNWs decorated with Pd nanoparticles by using methods 1 and 2, respectively. The sensitivity (*S*) of the SiNW was defined by $S = (R_{H_2} - R_{air}) / R_{air} \times 100$ (%) where *R*_{air} and *R*_{H₂} are the resistance of the Pd-decorated SiNW in air and in H₂, respectively. The response time of the sensor was defined as the time interval between 10 % and 90% increase of sensor resistance. The sensitivity and response time of the Pd-decorated SiNW sensor by using method 1 were 70 % and 750 sec, respectively. The sensitivity of 53 % and response time of 26 seconds were observed for Pd-decorated SiNW by method 2. Also, H₂ response of bare SiNW was monitored to verify the effectiveness of the Pd nanoparticle coating on the H₂ sensing. As shown in Fig. 5(c), a bare SiNW does not respond to H₂ gas. Therefore, we can conclude that selective surface decoration of SiNW by Pd nanoparticles enables the sensing capability to the H₂ gas.

When Pd is exposed to H₂ gas, it will absorb H₂ gas and form palladium hydride (PdH_x). The coverage (θ)¹⁷ of hydrogen atoms is a function of partial pressure of H₂ (*P*_{H₂}) as below.

$$\theta / (1 - \theta) = (k_1 / k_{-1})^{1/2} P_{H_2}^{1/2}$$

where *k*₁ and *k*₋₁ are the absorption and desorption constants, respectively.

As the coverage of hydrogen increases, the work function of PdH_x is decreased²¹. Therefore, the work function of PdH_x is also a function of *P*_{H₂}. When PdH_x is formed, band bending occurs by the difference of Fermi level (*E*_F) between SiNW and PdH_x and thus the electric conductivity of the SiNW decreases due to



Applied voltage	0.5V	10V	20V	30V
Sensitivity (= (R _{H₂} -R _{air})/R _{air} ×100)	3470%	450%	100%	106%
Response time (from 10% to 90%)	930sec	400sec	385sec	24sec

Fig. 6 Hydrogen sensing with self-heated silicon nanowire with a surface coating of Pd nanoparticles: Applied voltages of (a) 0.5 V, (b) 10 V, (c) 20 V, and (d) 30 V. Blue area represents hydrogen exposure period and other areas represent the air exposure. Sensitivity and response time of self-heated and Pd decorated silicon nanowire are summarized in the table.

narrow path for the electric conduction. Therefore, when *P*_{H₂} increases, the electrical conductivity of Pd decorated SiNW is decreased.

The self-heating of SiNWs can be used for improving the response speed of the sensor by increasing the reaction temperature. Fig. 6 (a-d) show the results of H₂ sensing by Pd-decorated SiNWs (method 2) with self-heating, where 0.5 % H₂ gas mixed in air was used as a target gas. Different DC voltages (0.5 V, 10 V, 20 V, and 30 V) were applied across Pd decorated SiNW to investigate the effect of self-heating. The sensitivity and the response time with various applied voltages are summarized in a table in Fig. 6. Lower sensitivity and faster response were observed as higher voltage was applied. When an electrical bias of 30 V was applied, we could observe 32.7 times lower sensitivity but 38.8 times shorter response time than when electrical bias of 0.5 V was applied. Also, fast recovery of resistance was observed by applying a high electrical bias. The recovery time is defined as the time interval from the point of gas shut-off to the point of 90% of final saturation. The recovery times were measured to be 1350 sec and 590 sec for 0.5V and 30V, respectively.

The atomic ratio of hydrogen to palladium (*x*) in palladium hydride (PdH_x) is a function of temperature and partial pressure of H₂. As the temperature is increased, the hydrogen content *x* in PdH_x is decreased²². Therefore, the electrical conductive path in SiNW is wider at high temperature due to the reduced difference of work function. This means that the sensitivity at high temperature is lower than at low temperature. However, as the temperature is increased, absorption and desorption of hydrogen occur faster due to higher kinetic energy of hydrogen. Therefore, the response and recovery times are shorter at higher temperature.

Conclusions

In summary, a novel method for selective surface modification of SiNW array was developed in this work. Selective surface modification of a SiNW could be achieved simply by localized temperature control via Joule heating of the SiNW. This method does not require tedious alignment process for selective and localized surface modification, differently from previously developed methods. We expect that high-performance, integrated, and multiplexed nanowire sensor array can be easily fabricated by using our proposed method.

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